

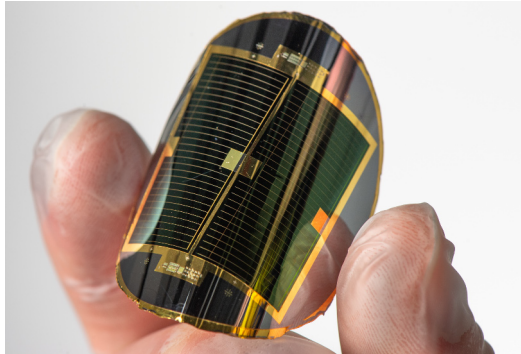
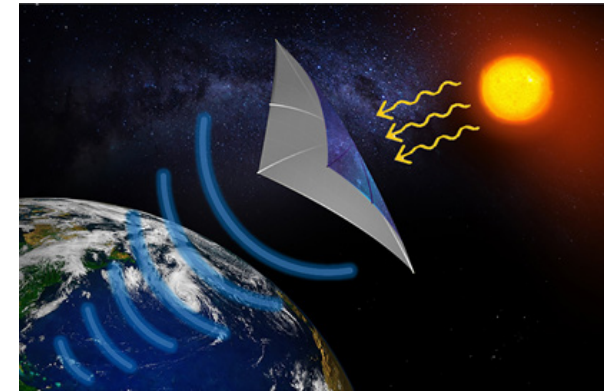


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Low-Cost PV Substrate Maturation (23NA-I-017)



Flexible, lightweight solar cell with substrate removed

The What

High-efficiency (>30%), low-cost, low-mass photovoltaic (PV) devices are a key enabler for current and future capabilities

Technology Improvements:

- Substrates represent >90% of the PV mass and ~30% of the cost, but are not needed in the final product
- This work identified and helped mature promising substrate technologies
- Success criteria involved ability to exfoliate a device quickly and easily without damaging the device and the ability to potentially achieve high-throughput and low cost at scale

The Why

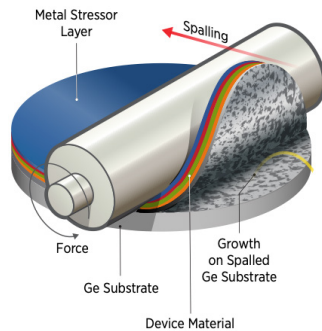
Reduction of PV cost from ~\$150/W to <\$30/W, with pathway to <\$1/W. Reduction enables widespread use of PV for DOD missions. >\$180M in savings for each 1.5 MW Solar Power Satellite, 2.9MKg/yr CO2 savings for each FOB.

Decreases dependence on foreign supplies of semiconductor substrates.

Reusable substrates enable low-mass PV for large-scale space installations at one-tenth the cost

Controlled Ge spalling

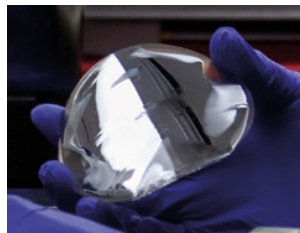
Partner: Colorado School of Mines
(PI: Dr. Corinne Packard)



- Pros**
- Low-cost processing
 - High throughput
 - Parity devices
 - No surface reparation
 - Compatible with standard 3J space cells
- Cons**
- Small regions of surface morphology
 - Needs equipment design/understanding

Acoustic GaAs spalling

Developer: Crystal Sonic

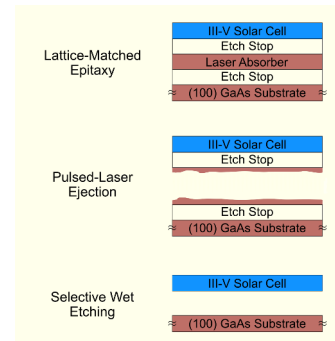


https://compoundsemiconductor.net/article/117366/A_sound_approach_to_cutting_costs

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Laser ablation liftoff

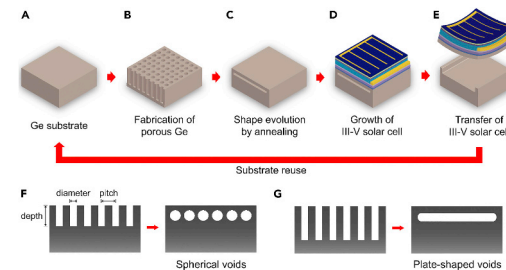
Partner: Stanford University
(PI: Dr. Bruce Clemens)



- Pros**
- Low-cost processing
 - High throughput
- Cons**
- No device demo
 - Insoluble etch products?
 - Needs liftoff area scaling

Porous Ge

Developer: Université de Sherbrooke



- Pros**
- Low-cost processing
- Cons**
- Needs parity device demonstration

Development of promising substrate reuse technologies continuing

This project will mature the most promising reuse technologies based on the promise for low-cost, high-throughput production and transition to industry.